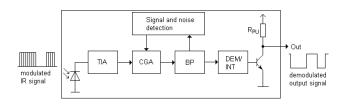


DATASHEET

Infrared Receiver Control Receiver Module EAIRMLA0 & EAIRMLA1



Block Diagram



Features

- · High protection ability against EMI
- · Available for various carrier frequencies
- · Min burst length: 6 cycles
- Min gap length: 10 cycles
- · Low operating voltage
- · High immunity against ambient light
- · Long reception range
- · High sensitivity
- · Pb free and RoHS compliant
- · Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

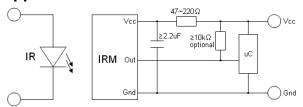
- The device is miniature SMD type infrared receiver that has been developed and designed by utilizing the latest IC technology.
- The PIN diode and preamplifier are assembled onto a lead frame and molded into an epoxy package which operated an IR filter. The demodulated output signal can directly be decoded by a microprocessor.

Applications

- Light detecting portion of remote control
- · AV instruments such as Audio, TV, VCR, CD, MD, etc
- · Home appliances such as Air-conditioner, Fan, etc
- 0ther devices using IR remote control
- · CATV set top boxes
- Multi-media Equipment



Application Circuit



Parts Table

Model No.	Carrier Frequency
EAIRMLA0	36 kHz
EAIRMLA1	38 kHz

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	6	V
Operating Temperature	Topr	-20 ~ +80	$^{\circ}$ C
Storage Temperature	Tstg	-40 ~ +85	$^{\circ}$ C
Soldering Temperature *1	Tsol	260	$^{\circ}\mathbb{C}$

^{*1 4}mm from mold body for less than 10 seconds



Electro-Optical Characteristics (Ta=25°℃)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Current consumption	lcc	-	0.4	0.6	mA	No input signal
Supply voltage	V _{CC}	2.7	-	5.5	V	
Peak wavelength	λ_{p}		940		nm	
Reception range	L_0	8			m	See chapter ,Test method'
	L ₄₅	5				
Half angle(horizontal)	ϕ_{h}		±45		deg	
Half angle(vertical)	ϕ_{v}		±45		deg	
High level pulse width	T _H	450	-	700	μs	Test signal
Low level pulse width	T_L	500	-	750	μs	 according to figure 1
High level output voltage	V_{OH}	Vcc-0.4			V	$I_{SOURCE} {\le} 1 \mu A$
Low level output voltage	V _{OL}		0.2	0.5	V	I _{SINK} ≦2mA
Internal pull up resistor	R_{PU}	85	100	115	kΩ	



Test method

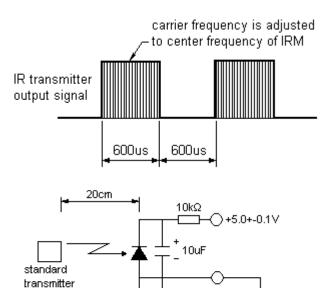
The specified electro-optical characteristics are valid under the following conditions.

- 1. Measurement environment
 - A place without extreme light reflections.
- 2. External light

The environment contains an ordinary, white fluorescent lamp without high frequency modulation. The color temperature is 2856K and the illumination at the IR receiver is less than 10 Lux ($Ev \le 10Lux$).

- 3. Standard transmitter
 - The test transmitter is calibrated by using the circuit shown in figure 2. The radiation intensity of the transmitter is adjusted until **Vo=400mVp-p.** Both, the test transmitter and the photo diode, have a peak wavelength of 940nm. The photo diode for calibration is PD438B (λp=940nm, Vr=5V).
- 4. The measurement system is shown in Fig.-3

Fig.-1 Transmitter Wave Form



100kΩ

D.U.T output Pulse

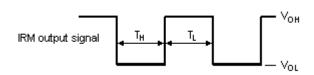
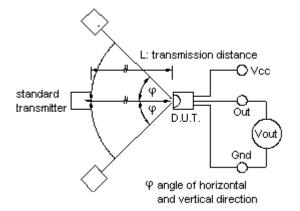


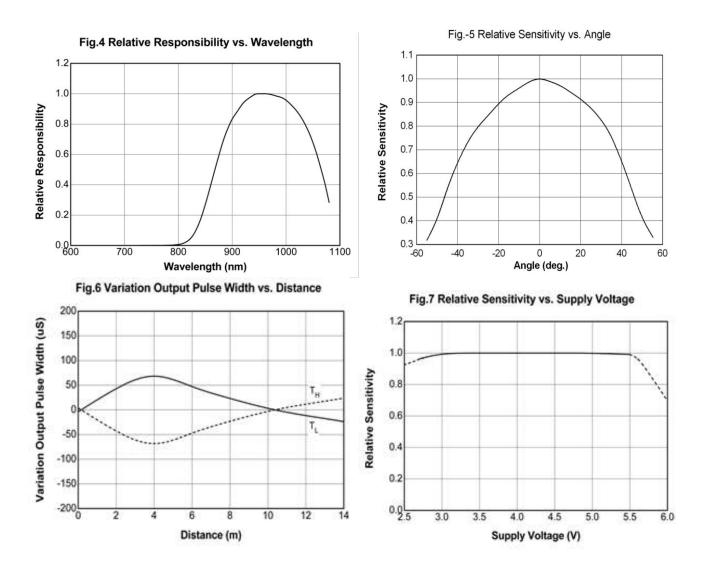
Fig.-3 Measuring System

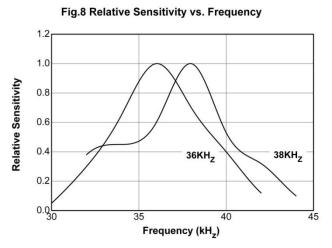


Oscilloscope



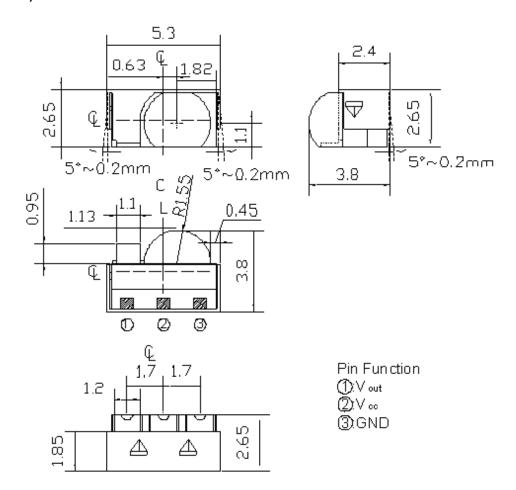
Typical Electro-Optical Characteristics Curves





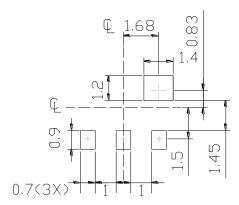


Package Dimension (Dimensions in mm)



Note :Tolerances unless dimensions ± 0.5 mm.

Recommended pad layout for surface mount leadform

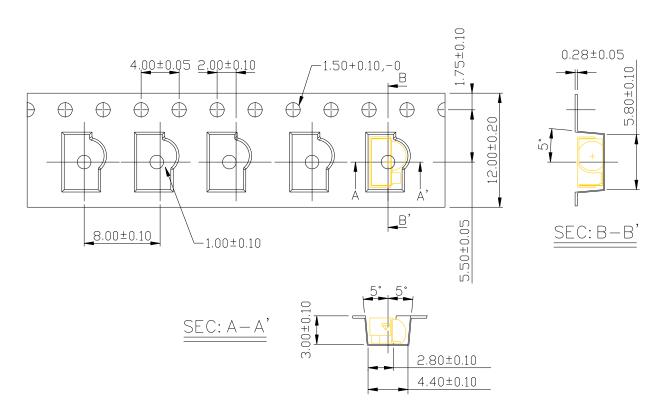




Code information

Protocol	Suitable	Protocol	Suitable
JVC	Yes	RCA	Yes
Matsushita	Yes	Sharp	Yes
Mitsubishi	Yes	Sony 12 Bit	Yes
NEC	Yes	Sony 15 Bit	No
RC5	Yes	Sony 20Bit	No
RC6	Yes	Toshiba	Yes
RCMM	Yes	Zenith	Yes
RCS-80	Yes	Continuous Code	Yes

Tape & Reel Packing Specifications (Dimensions in mm)

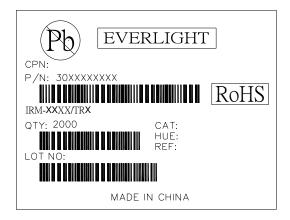


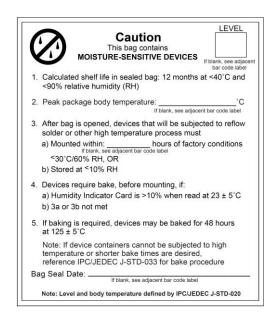
Packing Quantity

2000 pcs / Reel 5 Reels / Carton



Label format





Moisture Classification-storage and used condition label

Recommended method of storage

The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

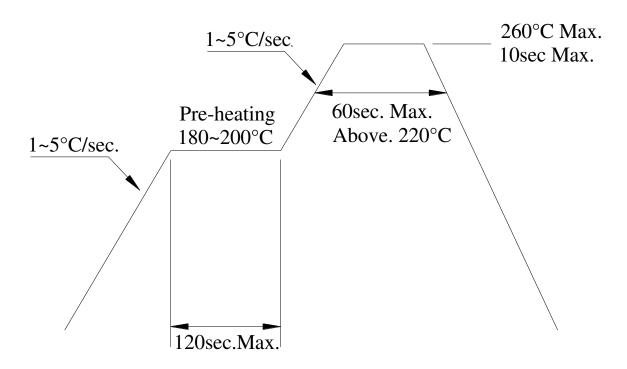
- 1. Shelf life in sealed bag from the bag seal date: 12 months at < 40 °C and < 90% relative humidity (RH)
- 2. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must mounted within 72 hours of factory conditions < 30 °C/60%RH.
- 3. If the moisture absorbent material (silica gel) has faded away or the IRM has exceeded the storage time. Baking treatment is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the conditions: 60±5°C for 96 hours.

ESD Precaution

Proper storage and handing procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Anti-static bag. Electro-Static Sensitive Devices warning labels are on the packing.



Solder Reflow Temperature Profile



Note:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the IRM device during heating.
- 3. After soldering, do not warp the circuit board.

Application Restrictions

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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